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SCOPE OF THE JOURNAL

International Journal of Embedded Systems and Applications (IJESA) is a quarterly open access peer-reviewed journal that publishes articles which contribute new results in all areas of the Embedded Systems and applications. The goal of this journal is to bring together researchers and practitioners from academia and industry to focus on understanding Embedded Systems and establishing new collaborations in these areas.

Authors are solicited to contribute to the journal by submitting articles that illustrate research results, projects, surveying works and industrial experiences that describe significant advances in the areas of Embedded Systems & applications.

Topics of interest

* Application-specific processors and devices
* Business Applications
* Component and binding models
* Embedded computing education
* Embedded hardware support
* Embedded software
* Embedded system architecture
* Hardware and software co-design
* Industrial practices and benchmark suites
* Integration with business logic
* Integration with SOA
* Middleware
* Networked Embedded Systems
* Policy-based management
* Programming abstractions
* Real-time systems
* Recent Trends
* Service-Oriented architectures
* Testing techniques

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Authors are invited to submit papers for this journal through **Submission System**. Submissions must be original and should not have been published previously or be under consideration for publication while being evaluated for this Journal. For paper format download the template in this page

Process

Submissions are accepted for review with the understanding that the same work has been neither submitted to, nor published in, another publication. Simultaneous submission to other publications will result in immediate rejection of the paper. Papers are not within the journal scope will be rejected immediately after the pre review process.

All manuscripts will be subject to a well established, fair, unbiased peer review and refereeing procedure, and are considered on the basis of their significance, novelty and usefulness to the Journals readership. The reviewing structure will always ensure the anonymity of the referees & it will be reviewed by 3 experts in the field. The review output will be one of the following decisions:

1. Accept
2. Accept with minor changes
3. Weak Accept with major changes
4. Reject

The review process may take approximately two ~three months to be completed. The Editor reserves the right to reject a paper if it does not meet the aims and scope of the journal, it is not revised well.

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